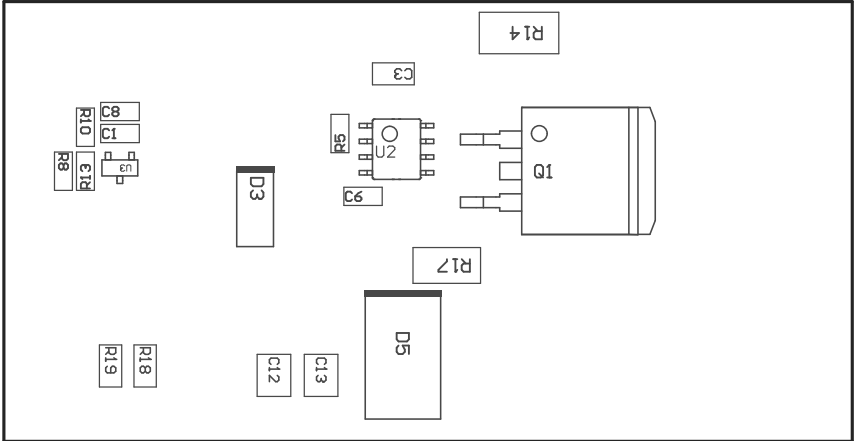


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: 001

| | | | |
|----------------------------------|----------------------|------------|--------------------------------|
| PCB VIEWED FROM TOP SIDE | BOARD #: PMP10834 | REV: A | SUN REV: Not In VersionControl |
| | | | |
| PLOT NAME = Top Assembly Drawing | GENERATED : 6/4/2015 | 2:24:17 PM | TEXAS INSTRUMENTS |



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: 001

| | | | |
|-------------------------------------|---------------------------------|--------|--------------------------------|
| PCB VIEWED FROM BOTTOM SIDE | BOARD #: PMP10834 | REV: A | SUN REV: Not In VersionControl |
| | | | |
| PLOT NAME = Bottom Assembly Drawing | GENERATED : 6/4/2015 2:24:18 PM | | TEXAS INSTRUMENTS |

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